

Product Description

FINISH: THIS BOARD SHALL BE IMMERSION GOLD PLATED ACCORDING TO IPC-6012. THICKNESS SHALL BE .050uM OVER 3-6uM NICKEL.

COPPER PLATE HOLES MINIMUM .025 AVG, .020 MIN.. HOLES MAY NOT BE PLUGGED

Pack with colorless transparent bubble film ,25 PCS/ bag, put desiccant in flank, put humidity indicator card on top side

Layer structure

L1-----HOZ

- PP 0.234mm -

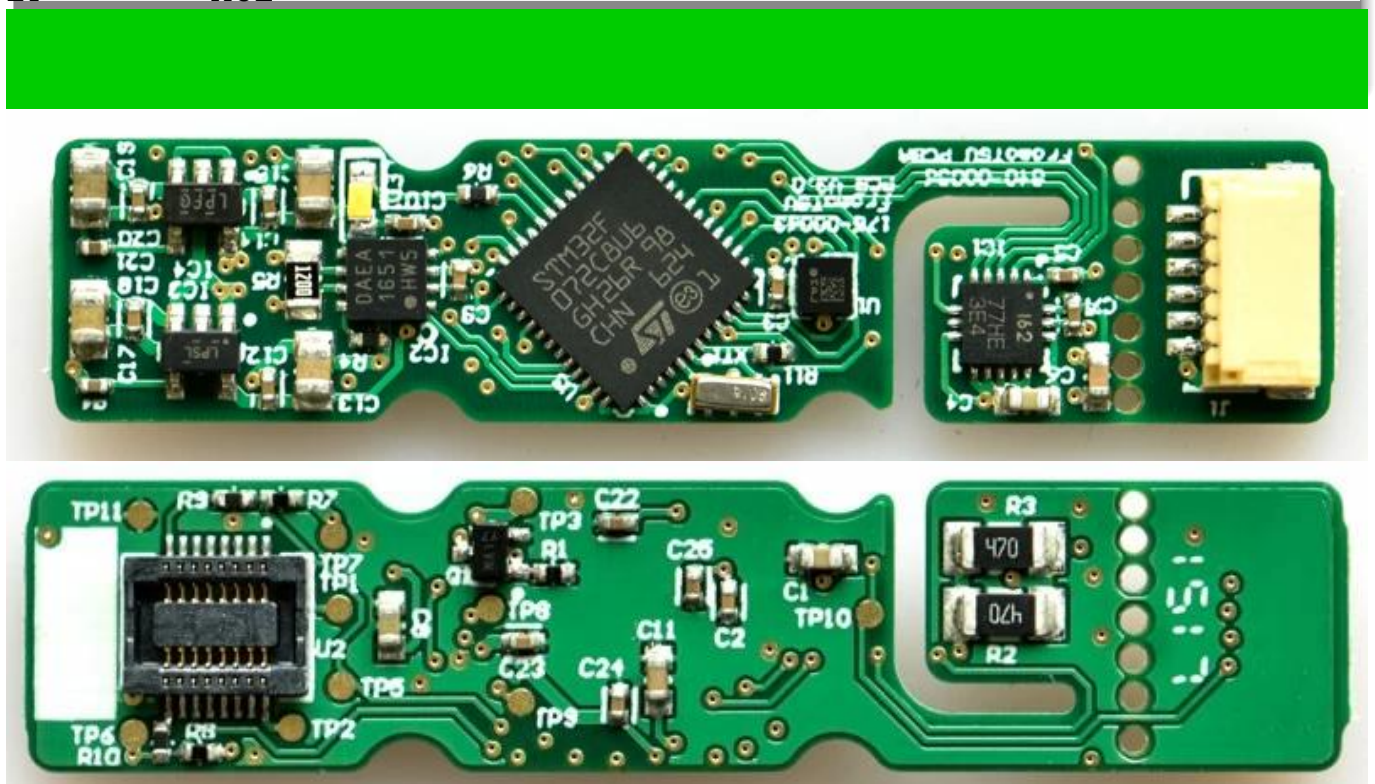
L2-----1OZ

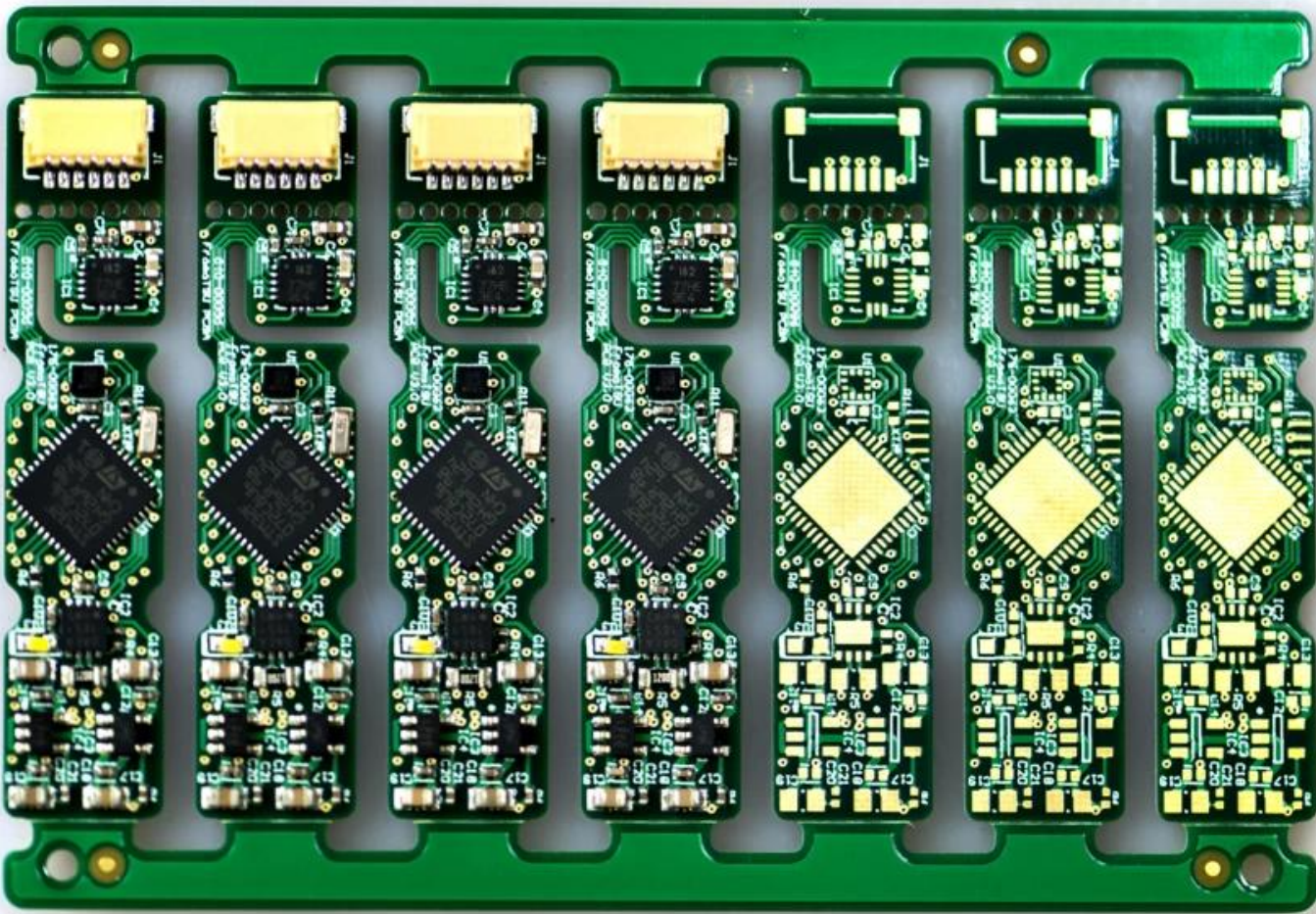
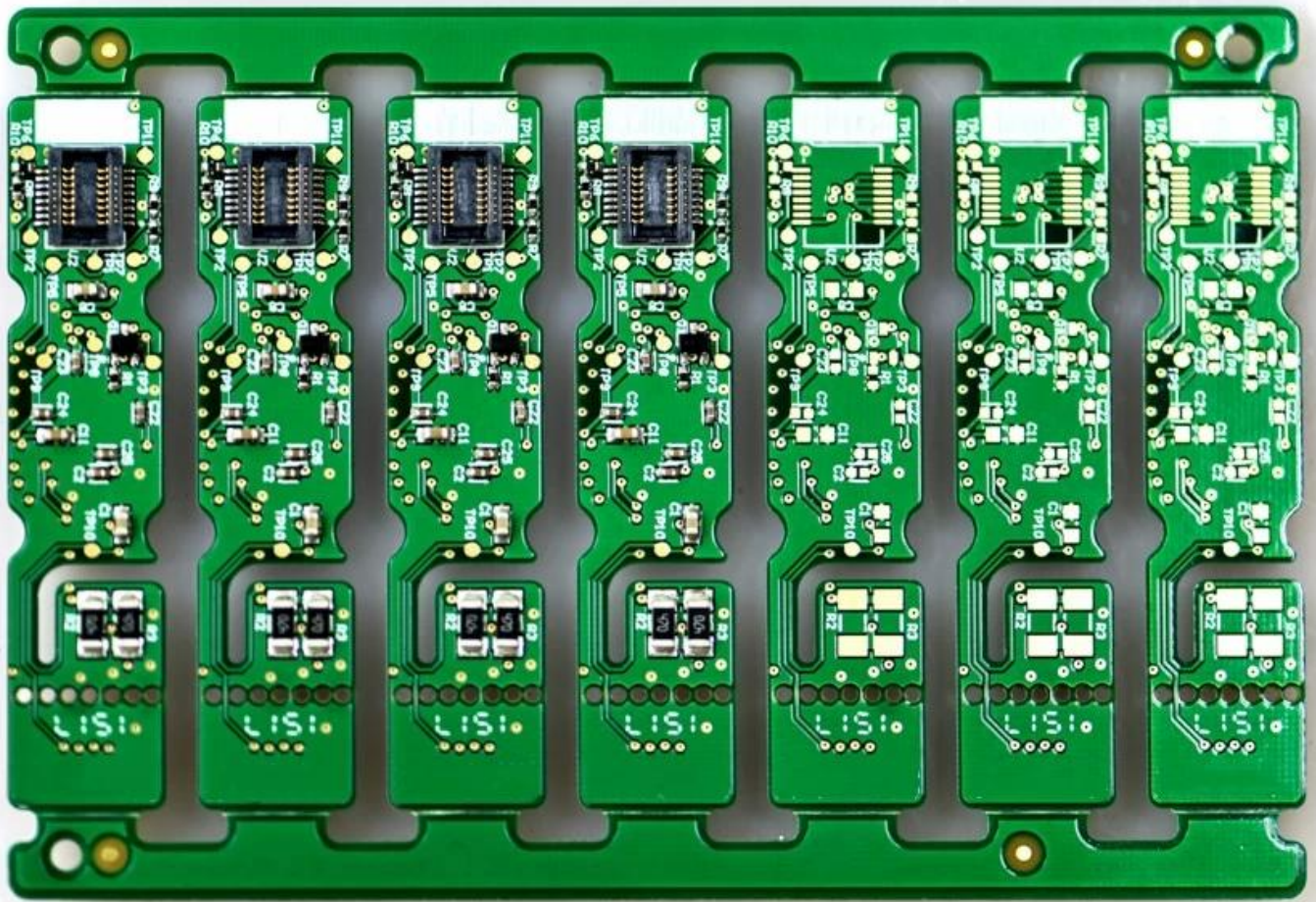
- CORE 0.127mm -

L3-----1OZ

- PP 0.234mm -

L4-----HOZ





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